

## VERSACLOCK® LOW POWER CLOCK GENERATOR

#### **IDT5P49EE802**

## **Description**

The IDT5P49EE802 is a programmable clock generator intended for low power, battery operated consumer applications. There are four internal PLLs, each individually programmable, allowing for up to eight differrent output frequencies. The frequencies are generated from a single reference clock. The reference clock can come from either a TCXO or fundamental mode crystal. An additional 32kHz crystal oscillator is available to provide a real time clock or non-critical performance MHz processor clock.

The IDT5P49EE802 can be programmed through the use of the I<sup>2</sup>C interfaces. The programming interface enables the device to be programmed when it is in normal operation or what is commonly known as in system programmable. An internal EEPROM allows the user to save and restore the configuration of the device without having to reprogram it on power-up.

Each of the four PLLs has an 8-bit reference divider and a 11-bit feedback divider. This allows the user to generate four unique non-integer-related frequencies. The PLL loop bandwidth is programmable to allow the user to tailor the PLL response to the application. For instance, the user can tune the PLL parameters to minimize jitter generation or to maximize jitter attenuation. Spread spectrum generation is supported on one of the PLLs.

Spread spectrum generation is supported on one of the PLLs. The device is specifically designed to work with display applications to ensure that the spread profile remains consistent for each HSYNC in order to reduce ROW noise. It also may operate in standard spread sepctrum mode.

There are total six 8-bit output dividers. Outputs are LVCMOS. The outputs are connected to the PLLs via the switch matrix. The switch matrix allows the user to route the PLL outputs to any output bank. This feature can be used to simplify and optimize the board layout. In addition, each output's slew rate and enable/disable function can be programmed.

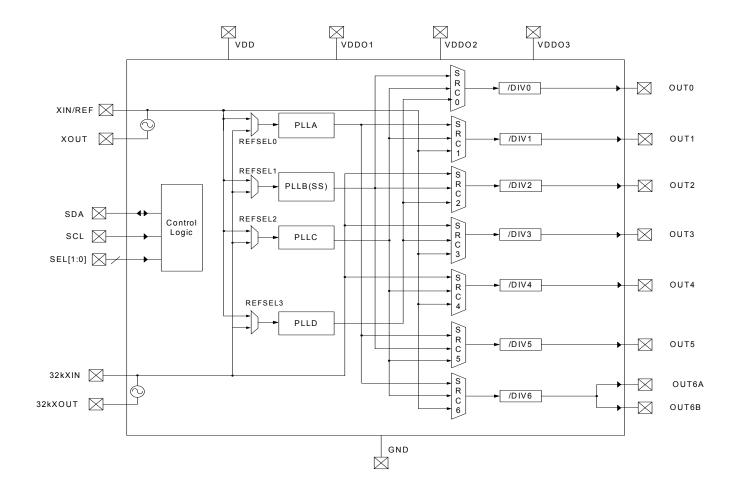
#### **Target Applications**

- Smart Mobile Handset
- Personal Navigation Device (PND)
- Camcorder
- DSC
- Portable Game Console
- Personal Media Player

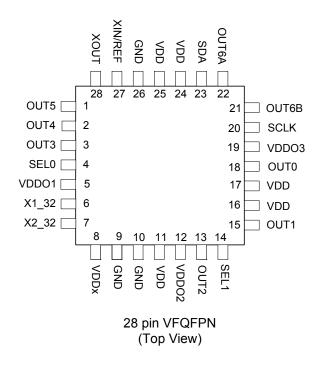
#### **Features**

- Four internal PLLs
- Internal non-volatile EEPROM
  - Internal I<sup>2</sup>C EEPROM master interface
- FAST (400kHz) mode I<sup>2</sup>C serial interfaces
- Input Frequencies
  - TCXO: 10 MHz to 40 MHzCrystal: 8 MHz to 30 MHzRTC Crystal: 32.768 kHz
- Output Frequency Ranges: kHz to 120 MHz
- Each PLL has an 8-bit reference divider and a 11-bit feedback-divider
- 8-bit output-divider blocks
- One of the PLLs support Spread Spectrum generation capable of configuration to pixel rate, with adjustable modulation rate and amplitude to support video clock with no visible artifacts
- I/O Standards:
  - Outputs 1.8V/2.5V/3.3 V LVTTL/ LVCMOS
- 3 independent adjustable VDDO groups.
- Programmable Slew Rate Control
- Programmable Loop Bandwidth Settings
- · Programmable output inversion to reduce bimodal jitter
- Individual output enable/disable
- Power-down/Sleep mode
  - 10µA max in power down mode
  - 32kHz clock output active sleep mode
  - 100µA max in sleep mode
- 1.8V VDD Core Voltage
- Available in 28 pin 4x4mm QFN packages
- -40 to +85 C Industrial Temp operation

## **Functional Block Diagram**



## **Pin Assignment**



## **Pin Descriptions**

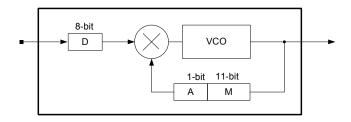
Pin Name	Pin #	I/O	Pin Type	Pin Description	
OUT5	1	0	Adjustable	Configurable clock output 5. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.	
OUT4	2	0	Adjustable	Configurable clock output 4. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.	
OUT3	3	0	Adjustable	Configurable clock output 3. Single-ended output voltage lever are register controlled by either VDDO1, VDDO2 or VDDO3.	
SEL0	4	I	LVTTL	Configuration select pin. Weak internal pull down resistor.	
VDDO1	5		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT6. VDDC must be greater than or equal to both VDDO2 and VDDO3.	
X132k	6	I	LVTTL	32kHz CRYSTAL_IN Reference crystal input	
X232k	7	I	LVTTL	32kHz CRYSTAL_OUT Reference crystal feedback.	
VDDx	8		Power	Crystal oscillator power supply. Connect to 1.8V. Use filtered analog power supply if available.	
GND	9		Power	Connect to Ground.	
GND	10		Power	Connect to Ground.	
VDD	11		Power	Device power supply. Connect to 1.8V.	
VDDO2	12		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT6.	

Pin Name	Pin #	I/O	Pin Type	Pin Description		
OUT2	13	0	Adjustable	Configurable clock output 2. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.		
SEL1	14	I	LVTTL	Configuration select pin. Weak internal pull down resistor.		
OUT1	15	0	Adjustable	Configurable clock output 1. Single-ended output voltage levels are register controlled by either VDDO1, VDDO2 or VDDO3.		
VDD	16		Power	Device power supply. Connect to 1.8V.		
VDD	17		Power	Device power supply. Connect to 1.8V.		
OUT0	18	0	Adjustable	e Configurable clock output 0. Single-ended output voltage le are register controlled by either VDDO1, VDDO2 or VDDO3		
VDD03	19		Power	Device power supply. Connect to 1.8 to 3.3V. Using register settings, select output voltage levels for OUT0-OUT6.		
SCLK	20	Ι	LVTTL	I <sup>2</sup> C clock.		
OUT6B	21	0	Adjustable	Configurable clock output 6B. Output voltage level is controlled by VDDO1.		
OUT6A	22	0	Adjustable	Configurable clock output 6B. Output voltage level is controlled by VDDO1.		
SDA	23	I/O	LVTTL	Bidirectional I <sup>2</sup> C data.		
VDD	24		Power	Device power supply. Connect to 1.8V.		
VDD	25		Power	Device power supply. Connect to 1.8V.		
GND	26		Power	Connect to Ground.		
XIN/ REF	27	I	LVTTL	MHz CRYSTAL_IN Reference crystal input or external reference clock input.		
XOUT	28	0	LVTTL	MHz CRYSTAL_OUT Reference crystal feedback.		
EP				Exposed thermal pad should be externally connected to ground.		

Note 1: Outputs are user programmable to drive single-ended 1.8V/2.5V/3.3V LVTTL. Alway completely power up VDD and VDDx prior to applying VDDO power. Always power up device into "Active" configuration modes, prior to asserting Power Down/Sleep mode SEL=00.

Note 2: Default configuration CLK4=Buffered MHz Reference output and CLK2=Buffered 32.768kHz output. All other outputs are off.

### **PLL Features and Descriptions**



**PLL Block Diagram** 

	Ref-Divider (D) Values			Programmable Loop Bandwidth	Spread Spectrum Generation Capability
PLLA	1 - 255	1 or 4 <sup>1</sup>	6 - 2047	Yes	No
PLLB	1 - 255	4	6 - 2047	Yes	Yes
PLLC	1 - 255	1 or 8 bit divide <sup>2</sup>	6 - 2047	Yes	No
PLLD	1 - 255	1 or 4 <sup>1</sup>	6 - 2047	Yes	No

<sup>1.</sup>XDIVA or XDIVD=0, A=1. XDIVA or XDIVD=1, A=4.

#### **Crystal Input (XIN/REF)**

The crystal oscillators should be fundamental mode quartz crystals; overtone crystals are not suitable. Crystal frequency should be specified for parallel resonance with  $50\Omega$  maximum equivalent series resonance.

#### **Crystal Load Capacitors**

The device crystal connections should include pads for small capacitors from X1 to ground and from X2 to ground. These capacitors are used to adjust the stray capacitance of the board to match the nominally required crystal load capacitance. Because load capacitance can only be increased in this trimming process, it is important to keep stray capacitance to a minimum by using very short PCB traces (and no vias) between the crystal and device. Crystal capacitors must be connected from each of the pins X1 and X2 to ground.

The crystal cpacitors are internal to the device and have an effective value of 8pF.

# Reference Pre-Divider, Reference Divider, Feedback-Divider and Post-Divider

Each PLL incorporates an 8-bit reference-scaler and a 11-bit feedback divider which allows the user to generate four unique non-integer-related frequencies. PLLA and PLLD each have a feedback pre-divider that provides additional multiplication for kHz reference clock applications. Each output divider supports 8-bit post-divider. The following equation governs how the output frequency is calculated.

$$F_{OUT} = \frac{F_{IN} * \left(\frac{A*M}{D}\right)}{ODIV}$$
 (Eq. 2)

Where  $F_{IN}$  is the reference frequency, A is the feedback pre-divider value, M is the feedback-divider value, D is the reference divider value, ODIV is the total post-divider value, and  $F_{OUT}$  is the resulting output frequency. Programming any of the dividers may cause glitches on the outputs.

<sup>2.</sup>XDIVC =0, A=1. XDIVC=1 turns on 8 bit predivide multiplier, A=FBC2[7:0]. Total feedback divide equals FBC[10:0] \*FBC2[7:0].

# SPREAD SPECTRUM GENERATION (PLLB)

PLLB has spread spectrum generation capability, which users have the option of turning on and off. Spread spectrum profile, frequency, and spread are fully programmable (within limits). The programmable spread spectrum generation parameters are NC[10:0], MOD[12:0], and NSS[10:0] bits. To enable spread spectrum, set SSENB\_B=0.

The spread spectrum circuitry was specifically developed to accommodate video display applications. The spread modulation frequency can be defined to exactly equal the horizontal line frequency (HSYNC)

#### NC[10:0]

These bits are used to determine the number of pulses per spread spectrum cycle. For video applications, NC is the number of pixels on the horizontal display row (or integer multiple of displayed pixels in a row). By matching the spread period to the screen, no tearing or "shimmer" will be apparent.

NC must be an even number to insure that the upward spread transition has the same number of steps as the downward spread transition.

For non-video applications, this can also be seen as the number of clock cycles for a complete spread spectrum period.

#### MOD[12:0]

These bits relate the VCO frequency to the target average spread output frequency  $(F_{MID})$ .

$$F_{MID} = (F_{VCO}) / 8$$

$$F_{MAX} = F_{MID} + (SS\% * F_{MID})$$

$$F_{MIN} = F_{MID} - (SS\% * F_{MID})$$

$$MOD = (F_{REF}^* NC) / (2 * F_{MID})$$

#### NSS[10:0]

These bits control the amplitude of the spread modulation.

$$NSS = (NC/2) + (NC/8) * (F_{MAX} - F_{MIN}) / F_{MID}$$

#### Modulation frequency:

 $F_{MOD} = F_{MID} / NC$  (Eq. 11)

#### **Video Example**

 $F_{REF}$  = 27 MHz,  $F_{OUT}$  = 27 MHz, 640 pixels per line, center spread of ±1%. Using  $F_{VCO}$ =432MHz, find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

NC = 640 (integer number of spread periods/screen)

$$MOD = (25MHz * 640)/(2 * 54MHz) = 160$$

NSS = (640/2) + (640/8)\*(27.27MHz-26.73MHz)/27MHz = 321.

 $F_{MOD} = 27MHz/640 = 11.8kHz.$ 

#### Non-Video Example

 $F_{REF}$  = 25MHz,  $F_{OUT}$  = 27 MHz, 31.25kHz modulation rate, center spread of ±1%. Find the necessary spread spectrum register settings.

$$F_{MID} = F_{VCO}/8$$

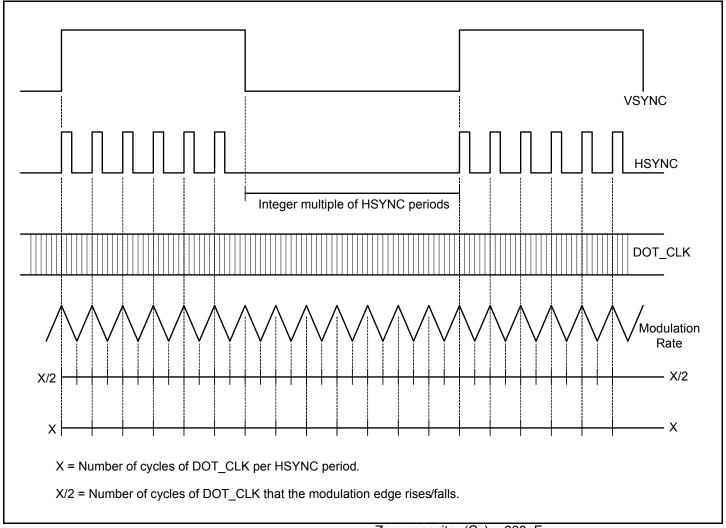
 $F_{MOD} = 31.25 \text{kHz} = 50.625 \text{MHz/NC}.$ 

NC = 1620

MOD = (25MHz \* 1620)/(2 \* 50.625MHz) = 400

NSS = (1620/2)+(1620/8)\*(27.27MHz-26.73MHz)/27MHz = 814.

## VSYNC, HSYNC, DOT\_CLK - Modulation Rate Relationship



#### **LOOP FILTER**

The loop filter for each PLL can be programmed to optimize the jitter performance. The low-pass frequency response of the PLL is the mechanism that dictates the jitter transfer characteristics. The loop bandwidth can be extracted from the jitter transfer. A narrow loop bandwidth is good for jitter attenuation while a wide loop bandwidth is best for low jitter generation. The specific loop filter components that can be programmed are the resistor via the RZ[4:0] bits, zero capacitor via the CZ[2:0] bits, pole capacitor via the CP[1:0] bits, and the charge pump current via the IP#[2:0] bits.

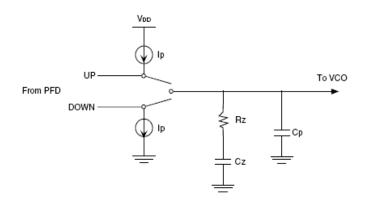
The following equations govern how the loop filter is set:

Zero capacitor (Cz) = 280pF

Pole capacitor (Cp) = 30pF

Charge pump (Ip) = IP#[2:0] uA

VCO gain (Kvco) =  $350MHz/V * 2\pi$ 



#### **PLL Loop Bandwidth:**

Charge pump gain  $(K\phi)$  = Ip /  $2\pi$ 

VCO gain (Kvco) =  $950MHz/V * 2\pi$ 

M = Total multiplier value (See the PRE-SCALERS, FEEDBACK-DIVIDERS, POST-DIVIDERS section for more detail)

$$\omega c = (Rz * K \phi * Kvco * Cz)/(M * (Cz + Cp))$$

 $Fc = \omega c / 2\pi$ 

Note, the phase/frequency detector frequency (FPFD) is typically seven times the PLL closed-loop bandwidth (Fc) but too high of a ratio will reduce your phase margin thus compromising loop stability.

To determine if the loop is stable, the phase margin  $(\phi m)$  would need to be calculated as follows.

#### Phase Margin:

$$\omega z = 1 / (Rz * Cz)$$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp)$$

$$\phi m = (360 / 2\pi) * [tan^{-1}(\omega c / \omega z) - tan^{-1}(\omega c / \omega p)]$$

To ensure stability in the loop, the phase margin is recommended to be  $> 60^{\circ}$  but too high will result in the lock time being excessively long. Certain loop filter parameters would need to be compromised to not only meet a required loop bandwidth but to also maintain loop stability.

#### **Example**

Fc = 150KHz is the desired loop bandwidth. The total A\*M value is 160. The  $\zeta$ (damping factor) target should be 0.7, meaning the loop is critically damped. Given Fc and A\*M, an optimal loop filter setting needs to be solved for that will meet both the PLL loop bandwidth and maintain loop stability.

Choose a mid-range charge pump from register table

$$K\phi * Kvco = 300MHz/V * 40uA = 12000A/Vs$$

$$\omega c = 2\pi * Fc = 9.42x10^{5} s^{-1}$$

$$\omega p = (Cz + Cp)/(Rz * Cz * Cp) = \omega z (1 + Cz / Cp)$$

Solving for Rz, the best possible value Rz=30kOhms (RZ[1:0]=10) gives

$$\zeta = 1.2$$

Solving back for the PLL loop bandwidth, Fc=149kHz.

The phase margin must be checked for loop stability.

$$\phi m = (360 / 2\pi) * [tan_{-1} (9.42x10^5 s^{-1} / 1.19x10^5 s^{-1}) - tan_{-1}^{-1} (9.42x10^5 s^{-1} / 1.23x10^6 s^{-1})] = 45^{\circ}$$

The phase margin would be acceptable with a fairly stable loop.

## SEL[1:0] Function

The IDT5P49EE802 can support up to three unique configurations. Users may pre-programmed all these configurations, and select the configurations using SEL[1:0] pins. Alternatively, users may use I2C interface to configure these registers on- the-fly.

Always power up with SEL1=1 and/or SEL0=1. Do not power up device into power down mode SEL=00.

Power Down/Sleep Mode is selected by the No PD bit. No PD=0 enables Power Down mode with no outputs. No PD=1 enables sleep mode with 32kHz output on OUT4.

SEL1	SEL0	Configuration Selections
0	0	Power Down/Sleep Mode
0	1	Select CONFIG0
1	0	Select CONFIG1
1	1	Select CONFIG2

## **Configuration OUTx IO Standard**

Users can configure the individual output IO standard from

a single 3.3V power supply. Each output can support 1.8V/ 2.5V or 3.3V LVCMOS. VDDO1 must have the highest voltage of any pin on the device. VDDO2 and VDDO3 may have any value between 1.8V and VDDO1.

### **Programming the Device**

I<sup>2</sup>C may be used to program the IDT5P49EE802.

- Device (slave) address = 7'b1101010

## I<sup>2</sup>C Programming

The IDT5P49EE802 is programmed through an I2C-Bus serial interface, and is an I2C slave device. The read and write transfer formats are supported. The first byte of data after a write frame to the correct slave address is interpreted as the register address; this address auto-increments after each byte written or read.

SDA SDA SCL SCL Р

s

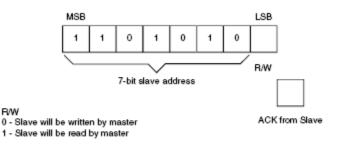
The frame formats are shown in the following illustration.

**Framing** 

Data Frame

Data is stable during

clock HIGH



The first byte transmitted by the Master is the Slave Address followed by the R/W bit. The Slave acknowledges by sending a "1" bit.

### First Byte Transmitted on I<sup>2</sup>C Bus

Stop Condition

#### External I<sup>2</sup>C Interface Condition

KEY:

_		
l ⊢rom	Masteri	to Slave

From Master to Slave, but can be omitted if followed by the correct sequence

Normally data transfer is terminated by a STOP condition generated by the Master. However, if the Master still wishes to communicate on the bus, it can generate a repeated START condition, and address another Slave address without first generating a STOP condition.

From Slave to Master

#### SYMBOLS:

ACK - Acknowledge (SDA LOW)
NACK - Not Acknowledge (SDA HIGH)
Sr - Repeated Start Condition
S - START Condition

P-STOP Condition

## **EEPROM Interface**

The IDT5P49EE802 can store its configuration in an internal EEPROM. The contents of the device's internal programming registers can be saved to the EEPROM by issuing a save instruction (ProgSave) and can be loaded back to the internal programming registers by issuing a restore instruction (ProgRestore).

To initiate a save or restore using I<sup>2</sup>C, only two bytes are transferred. The Device Address is issued with the read/write bit set to "0", followed by the appropriate command code. The save or restore instruction executes

after the STOP condition is issued by the Master, during which time the IDT5P49EE802 will not generate Acknowledge bits. The IDT5P49EE802 will acknowledge the instructions after it has completed execution of them. During that time, the I<sup>2</sup>C bus should be interpreted as busy by all other users of the bus.

On power-up of the IDT5P49EE802, an automatic restore is performed to load the EEPROM contents into the internal programming registers. The IDT5P49EE802 will be ready to accept a programming instruction once it acknowledges its 7-bit I<sup>2</sup>C address.

#### **Progwrite**

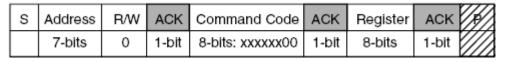
S	Address	R/W	ACK	Command Code	ACK	Register	ACK	Data	ACK	Р
	7-bits	0	1-bit	8-bits: xxxxxx00	1-bit	8-bits	1-bit	8-bits	1-bit	

#### **Progwrite Command Frame**

Writes can continue as long as a Stop condition is not sent and each byte will increment the register address.

#### **Progread**

Note: If the expected read command is not from the next higher register to the previous read or write command, then set a known "read" register address prior to a read operation by issuing the following command:



#### **Prior to Progread Command Set Register Address**

The user can ignore the STOP condition above and use a repeated START condition instead, straight after the slave acknowledgement bit (i.e., followed by the Progread command):

Sr	Address	R/W	ACK	ID Byte	ACK	Data_1	ACK	Data_2	ACK	Data_last	NACK	Р
	7-bits	1	1-bit	8 bits	1-bit	8-bits	1-bit	8-bits	1-bit	8-bits	1-bit	

#### **Progread Command Frame**

#### **Progsave**

s	Address	R/W	ACK	Command Code	ACK	Р
	7-bits	0	1-bit	8-bits:xxxxxx01	1-bit	

#### Note:

PROGWRITE is for writing to the IDT5P49EE802 registers. PROGREAD is for reading the IDT5P49EE802 registers. PROGSAVE is for saving all the contents of the IDT5P49EE802 registers to the EEPROM. PROGRESTORE is for loading the entire EEPROM contents to the IDT5P49EE802 registers.

#### **Progrestore**

s	Address	RW	ACK	Command Code	ACK	Р
	7-bits	0	1-bit	8-bits:xxxxxx10	1-bit	

During PROGRESTORE, outputs will be turned off to ensure that no improper voltage levels are experienced before initialization.

## I<sup>2</sup>C Bus DC Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>IH</sub>	Input HIGH Level		0.7xVDD		5.5	V
V <sub>IL</sub>	Input LOW Level				0.3xVDD	V
V <sub>HYS</sub>	Hysteresis of Inputs		0.05xVDD			V
I <sub>IN</sub>	Input Leakage Current	$V_{DD} = 0V$			±1.0	μΑ
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 3 mA			0.4	V

## I<sup>2</sup>C Bus AC Characteristics for Standard Mode

Symbol	Parameter	Min	Тур	Max	Unit
F <sub>SCLK</sub>	Serial Clock Frequency (SCL)	0		100	kHz
t <sub>BUF</sub>	Bus free time between STOP and START	4.7			μs
t <sub>SU:START</sub>	Setup Time, START	4.7			μs
t <sub>HD:START</sub>	Hold Time, START	4			μs
t <sub>SU:DATA</sub>	Setup Time, data input (SDA)	250			ns
t <sub>HD:DATA</sub>	Hold Time, data input (SDA) <sup>1</sup>	0			μs
t <sub>OVD</sub>	Output data valid from clock			3.45	μs
C <sub>B</sub>	Capacitive Load for Each Bus Line			400	pF
t <sub>R</sub>	Rise Time, data and clock (SDA, SCLK)			1000	ns
t <sub>F</sub>	Fall Time, data and clock (SDA, SCLK)			300	ns
t <sub>HIGH</sub>	HIGH Time, clock (SCLK)	4			μs
t <sub>LOW</sub>	LOW Time, clock (SCLK)	4.7			μs
t <sub>SU:STOP</sub>	Setup Time, STOP	4			μs

<sup>1)</sup> No activity is allowed on I<sup>2</sup>C lines until VDD>1.62V.

<sup>2)</sup> A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IH</sub>MIN of the SCLK signal) to bridge the undefined region of the falling edge of SCLK.

## I<sup>2</sup>C Bus AC Characteristics for Fast Mode

Symbol	Parameter	Min	Тур	Max	Unit
F <sub>SCLK</sub>	Serial Clock Frequency (SCL)	0		400	kHz
t <sub>BUF</sub>	Bus free time between STOP and START	1.3			μs
t <sub>SU:START</sub>	Setup Time, START	0.6			μs
t <sub>HD:START</sub>	Hold Time, START	0.6			μs
t <sub>SU:DATA</sub>	Setup Time, data input (SDA)	100			ns
t <sub>HD:DATA</sub>	Hold Time, data input (SDA) <sup>1</sup>	0			μs
t <sub>OVD</sub>	Output data valid from clock			0.9	μs
C <sub>B</sub>	Capacitive Load for Each Bus Line			400	pF
t <sub>R</sub>	Rise Time, data and clock (SDA, SCL)	20 + 0.1xC <sub>B</sub>		300	ns
t <sub>F</sub>	Fall Time, data and clock (SDA, SCL)	20 + 0.1xC <sub>B</sub>		300	ns
t <sub>HIGH</sub>	HIGH Time, clock (SCL)	0.6			μs
t <sub>LOW</sub>	LOW Time, clock (SCL)	1.3			μs
t <sub>SU:STOP</sub>	Setup Time, STOP	0.6			μs

<sup>1)</sup> No activity is allowed on I<sup>2</sup>C lines until VDD>1.62V.

<sup>2)</sup> A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V<sub>IH</sub>MIN of the SCLK signal) to bridge the undefined region of the falling edge of SCLK.

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the IDT5P49EE802. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Symbol	Description	Max	Unit
$V_{DD}$	Internal Power Supply Voltage	-0.5 to +4.6	V
VI	Input Voltage	-0.5 to +4.6	V
$V_{O}$	Output Voltage (not to exceed 4.6 V)	-0.5 to V <sub>DD</sub> +0.5	V
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C

## **Recommended Operation Conditions**

Symbol	Parameter	Min	Тур	Max	Unit
$V_{DD}$	Power supply voltage for core VDD	1.62	1.8	1.98	V
T <sub>A</sub>	Operating temperature, ambient	-40		+85	°C
C <sub>LOAD_OUT</sub>	Maximum load capacitance (3.3V LVTTL only)			15	pF
C <sub>LOAD_OUT</sub>	Maximum load capacitance (1.8V or 2.5V LVTTL only)			8	pF
F <sub>IN</sub>	External reference crystal	8		30	MHz
	External reference clock CLKIN	1		40	
t <sub>PU</sub>	Power up time for all V <sub>DD</sub> s to reach minimum specified voltage (power ramps must be monotonic)	0.05		5	ms

## Capacitance

Symbol	Parameter	Min	Тур	Max	Unit		
C <sub>IN</sub>	Input Capacitance	ut Capacitance 3					
Crystal Specifi	cations	·					
XTAL_FREQ	Crystal frequency	8		30	MHz		
XTAL_MIN	Minimum crystal load capacitance		TBD		pF		
XTAL_MAX	Maximum crystal load capacitance		35.4		pF		
XTAL_V <sub>PP</sub>	Voltage swing (peak-to-peak, nominal)	1.5	2.3	3.2	V		

## DC Electrical Characteristics for 3.3 Volt LVTTL <sup>1</sup>

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = 33mA	2.4		VDDO	٧
V <sub>OL</sub>	Output LOW Voltage	I <sub>OH</sub> = 33mA			0.4	٧
V <sub>IH</sub>	Input HIGH Voltage		2			٧
V <sub>IL</sub>	Input LOW Voltage				0.8	٧
I <sub>OZDD</sub>	Output Leakage Current	3-state outputs			5	μΑ

## DC Electrical Characteristics for 2.5Volt LVTTL <sup>1</sup>

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = 25mA	2.1		VDDO	٧
$V_{OL}$	Output LOW Voltage	I <sub>OH</sub> = 25mA			0.4	V
I <sub>OZDD</sub>	Output Leakage Current	3-state outputs			5	μΑ

## DC Electrical Characteristics for 1.8Volt LVTTL <sup>1</sup>

Symbol	Parameter	Test Conditions Min		Тур	Max	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = 18mA	0.65*VDDO		VDDO	٧
$V_{OL}$	Output LOW Voltage	I <sub>OH</sub> = 18mA			0.35*VDDO	٧
I <sub>OZDD</sub>	Output Leakage Current	3-state outputs			5	μΑ

## **Power Supply Characteristics for LVTTL Outputs**

Symbol	Parameter	Test Conditions	Тур	Max	Unit
I <sub>TOT</sub>	Total Power VDD Supply Current	F <sub>REFERENCE CLOCK</sub> = 25 MHz, C <sub>L</sub> = 7 pF	TBD		mA

Note 1: See "Recommended Operating Conditions" table. Alway completely power up VDD and VDDx prior to applying VDDO power.

## **AC Timing Electrical Characteristics**

(Spread Spectrum Generation = OFF)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
f <sub>IN</sub>	Input Frequency	Input Frequency Limit (CLKIN)	1 <sup>1</sup>		40	MHz
1 / t1	Output Frequency	Single Ended Clock output limit (LVTTL) 3.3V	0.001		120	MHz
		Single Ended Clock output limit (LVTTL) 2.5V	-		110	MHz
		Single Ended Clock output limit (LVTTL) 1.8V	-		100	MHz
f <sub>VCO</sub>	VCO Frequency	VCO operating Frequency Range	100		475	MHz
f <sub>PFD</sub>	PFD Frequency	PFD operating Frequency Range	0.50		20	MHz
t2	Input Duty Cycle	Duty Cycle for Input	40		60	%
t3	Output Duty Cycle	Measured at VDD/2	45	45		%
t4	Slew Rate, SLEWx(bits) = 00	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		3.5		V/ns
	Slew Rate, SLEWx(bits) = 01	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		2.75		
	Slew Rate, SLEWx(bits) = 10	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD (Output Load = 7 pF)		2		
	Slew Rate, SLEWx(bits) = 11	Single-Ended 3.3V LVCMOS Output clock rise and fall time, 20% to 80% of VDD Output Load = 7 pF)		1.25		
t5	Clock Jitter	Peak-to-peak period jitter, CLK outputs measured at VDD/2; f <sub>PFD</sub> >= 10 MHz Single output frequency only.			100	ps
		Peak-to-peak period jitter, CLK outputs measured at VDD/2; f <sub>PFD</sub> >= 10 MHz Multiple output frequencies switching.			200	ps
t6	Output Skew	Skew between OUT6 and OUT6B outputs.			200	ps
t7	Lock Time PLL Lock Time from Power-up (using MHz reference clock) <sup>2</sup>			5	20	ms
		PLL Lock Time from Power-up using 32.768kHz reference clock)		1	3	S
		PLL Lock time from shutdown mode			5	ms

<sup>1.</sup>Input clock (square wave) may be used at 1 MHz.

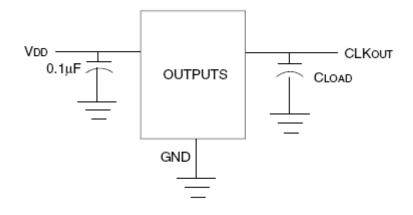
<sup>2.</sup>Time from supply voltage crosses VDD=1.62V to PLLs are locked.

## **Spread Spectrum Generation Specifications**

Symbol	Parameter	Description	Min	Тур	Max	Unit
f <sub>IN</sub>	Input Frequency	Input Frequency Limit	1 <sup>1</sup>		40	MHz
f <sub>MOD</sub>	Mod Frequency	Modulation Frequency	32		120	kHz
f <sub>SPREAD</sub>	Spread Value	Amount of Spread Value (programmable) - Down Spread	Programmable		%f <sub>OUT</sub>	
		Amount of Spread Value (programmable) - Center Spread	Pro	gramm	able	

Note 1: Practical lower frequency is determined by loop filter settings.

## Test Circuits and Conditions <sup>1</sup>

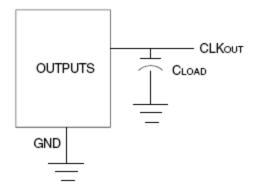


NOTE:

1. All Vco pins must be tied together.

**Test Circuits for DC Outputs** 

## Other Termination Scheme (Block Diagram)



Total load capacitance = 7pF

## **Programming Registers Table**

	Default									
Addr	Register Hex Value	7	6	5	4	3	2	1	0	Description
0x00	00	ONXTALB	CSX:	2[1:0]	CSX	1[1:0]	XTAL32ONB	R	eserved	ONXTALB - MHz Crystal active low CSX2 [1:0]- internal 32kHz crystal cap2 00 - 18pF; 10 - 30pF 01 - 24pF; 11 - 36pF CSX1 [1:0] - Internal 32kHz crystal cap1 00 - 0pF; 10 - 6pF 01 - 3pF; 11 - 9pF XTAL32ONB - 32k crystal active low
0x01	00	INV[0]	SLEW	/0[0:1]	No_PD	P	S0[2:1]	Re	eserved	No_PD - Enables/Disables 32kHz
0x02	00				Re	served	1			clock output on Config 00. No_PD=0 - 32kHz is off.
0x03	00	INV[1]	SLEW	/1[0:1]	Reserved	Р	S12:1]	R	eserved	No_PD=1 - 32kHz remains active.
0x04	00	INV[2]	SLEW	/2[0:1]	Reserved	P:	S2[2:1]	R	eserved	32kHz output must be on OUT4
0x05	00				Re	served				INV[#] - Invert output# SLEW#[0:1] - output# slew setting
0x06	00	INV[3]	SLEW	/3[0:1]	Reserved	P	S3[2:1]	R	eserved	0 0 - 5.1V/ns
0x07	00	INV[4]	SLEW	/4[0:1]	Reserved	P	S42:1]	R	eserved	0 1 - 4.4V/ns 1 0 - 2.8V/ns
80x0	00	INV[5]	SLEW	/5[0:1]	Reserved	P:	S5[2:1]	R	eserved	1 1 - 1.8V/ns
0x09	00	INV[6B]	INV[6A]	SLE	W6[0:1]		Res	erved		PS#[2:1] -Power Select 00 - Reserved 01 - CLK# connects to VDDO1 10 - CLK# connects to VDDO2 11 - CLK# connects to VDDO3
0x0A	00				Re	served				
0x0B	00				Re	served				
0x0C	00				Re	served				
0x0D	00				Re	served				
0x0E	00				RE	FA[7:0]				Configuration0 REFA[7:0] - Reference Divide PLLA
0x0F	00				FB	A[10:3)				FBA[10:0] - Feedback Divide PLLA
0x10	00			Reserved				FBA[2:0)		7
0x11	00	Reserved	XDIVA	RZ	·A[1:0]		IPA[2:0]		REFSELA	XDIVA - FB predivide PLLA; 0 - /1; 1 - /4 RZA[1:0] - Zero Resistor PLLA 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm IPA[2:0] - charge Pump Current PLLA 100 - 6.3uA 101 - 11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELA - Clock input PLLA 0 - MHz input 1 - 32kHz input
0x12	00				RE	FB[7:0]				REFB[7:0] - Reference Divide PLLB
0x13	00				FBI	B[10:3]				FBB[10:0] - Feedback Divide PLLB
0x14	00	MOD[4:0] FBB[2:0]								PLLB Spread Parameters MOD[12:0]
0x15	00				MO	D[12:5]	1			NC[10:0] NSS[12:0]
0x16	00				NC	[10:3]				1.00[12.0]
0x17	00			NSS[4:0]				NC[2:0]		7
0x18	00				NS	S[12:5]				7

	Default				E	Bit #				
Addr	Register Hex Value	7	6	5	4	3	2	1	0	Description
0x19 0x1A	40 00		Reserved	Rese	rved	IPB[2:0]		RZ REFSELB	B[1:0] SSENB_B	RZB[1:0] - Zero Resistor PLLB  00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm 11 - 80kOhm IPB[2:0] - charge Pump Current PLLB 000 - 0.37uA, 100 - 6.3uA 001 - 1.1uA, 101 - 11.9uA 010 - 1.8 uA, 110 - 17.7uA 011 - 3.4uA, 111 - 22.7uA REFSELB - Clock input PLLB
0x1B	00	REFC[7:0]								0 - MHz input 1 - 32kHz input REFC[7:0] - Reference Divide PLLC
0x1C	00					C[10:3]				FBC[10:0] - Feedback Divide PLLC
0x1D	00			Reserved				FBC[2:0]		• • • • • • • • • • • • • • • • • • •
0x1E	00				FB	C2[7:0]				FBC2 - Feedback Predivide PLLC Turn on using XDIVC=1
0x1F	00						XDIVC	REFSELC	RZC[1:0] - Zero Resistor PLLC 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm 11 - 80kOhm IPC[2:0] - charge Pump Current PLLC 100 - 6.3uA 101 - 11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELC 0 - MHz input 1 - 32kHz input	
0x20	00				RE	FD[7:0]				REFD[7:0] - Reference Divide PLLD
0x21 0x22	00			Reserved	FB	D[10:3]		EDD(0.0)		FBD[10:0] - Feedback Divide PLLD
0x23	00	XDIVD				IPD[2:0]		FBD[2:0]  REFSELD[1:0]		XDIVD - FB predivide PLLD; 0 - /1; 1 - /4 RZD[1:0] - Zero Resistor PLLD 00 - 5kOhm 01 - 10kOhm 10 - 30kOhm 11 - 80kOhm 11 - 80kOhm IPD[2:0] - charge Pump Current PLLD 100 - 6.3uA 101 - 11.9 uA 110 - 17.7 uA 111 - 22.7uA REFSELD[1:0] 00 - MHz input 11 - 32kHz input Others - Reserved
0x24	00	OD0[7:0]								OD#[7:0] - Output Divide#
0x25	00	Reserved								
0x26	00					D1[7:0] D2[7:0]				
0x27	00									
0x28	00									
0x29	00									
0x2A	00									
0x2B	00	OD5[7:0]								
0x2C	00				OI	06[7:0]				

Addr		Default				В	Bit #				
Oc. of to P.	Addr		7	6	5	4	3	2	1	0	Description
00 - off, 10 - PLLB   01 - 324ht Reference, 11 - PLLD   SRC1[1:0] - ODI source   00 - off, 10 - off, 10 - off, 10 - odi source   00 - odi	0x2D	00	SCR	6[1:0]	SCH5[1:0]		SCF	[1:0]	SCR3[1:0]		00 - off; 10 - PLLC 01 - PLLA; 11 - MHz Reference SRC5[1:0] - OD5 source 00 - off; 10 - PLLA 01 - PLLC; 11 - PLLB SRC4[1:0] - OD4 source 00 - off; 10 - MHz Reference 01 - PLLC; 11 - 32kHz Reference SRC3[1:0] - OD3 source 00 - off; 10 - 32kHz Reference
Ox.00   Ox.0	0x2E	00			SCR	l2[1:0]	SCF	R1[1:0]	Reserved		00 - off; 10 - PLLB 01 - 32kHz Reference; 11 - PLLD SRC1[1:0] - OD1 source 00 - off; 10 - PLLC 01 - PLLA; 11 - PLLD
Display   Disp			SCR	0[1:0]		Re		eserved			00 - off; 10 - PLLC
Display   Disp	0x31	00	PDB[6]	Reserved	OE[6B]	OE[6A]		Re	served		
Display							OE[2]			OE[0]	PDB[#]=0, OUT# driven low
Color											OUT# tri-stated.
Name	0x34	00		1		RE	FA[7:0]	-	I .		
D336   O0	0x35	00				FB/	A[10:3)				
0x38         00         REFB[7:0]           0x39         00         FBB[10:3]           0x3B         00         MOD[4:0]         FBB[2:0]           0x3B         00         MOD[12:5]         NC[2:0]           0x3D         00         NSS[4:0]         NC[2:0]           0x3E         00         NSS[12:5]         REFSLD           0x40         00         Reserved         REFSLB         SSENB_B           0x41         00         REFC[7:0]         REFC[10:3]           0x42         00         FBC[10:3]         FBC[2:0]           0x44         00         FBC[2:0]         REFSELD           0x44         00         FBC[2:0]         REFSELC           0x46         00         REFD[7:0]         REFSELC           0x47         00         RESERVED         FBD[10:3]           0x49         00         XDIVD         RZD[1:0]         REFSELD[1:0]           0x49         00         XDIVD         RZD[1:0]         REFSELD[1:0]           0x40         00         REFSELD[1:0]         REFSELD[1:0]           0x40         00         REFSELD[1:0]         REFSELD[1:0]           0x40         00         REFSELD[1:0] <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>FBA[2:0)</td> <td></td> <td></td>									FBA[2:0)		
Display			Reserved	XDIVA	RZA			IPA[2:0]		REFSELA	
0x3A         00         MOD[4:0]         FBB[2:0]           0x3B         00         MOD[12:5]         MOD[12:5]           0x3C         00         NS[4:0]         NC[2:0]           0x3F         00         NSS[12:5]         NS[12:5]           0x40         00         Reserved         REFSELB         SSENB_B           0x41         00         REFC[7:0]         REFSELB         SSENB_B           0x41         00         FBC[10:3]         FBC[2:0]           0x43         00         Reserved         FBC[7:0]         FBC[2:0]           0x44         00         FBC[2:0]         REFSELD         REFSELC           0x45         00         IPC[2:0]         RZC[1:0]         Reserved         XDIV         REFSELC           0x46         00         RESERVED         FBD[10:3]         FBD[2:0]         REFSELD[1:0]           0x48         00         RESERVED         FBD[2:0]         REFSELD[1:0]           0x4B         00         Reserved         Reserved         ODD[7:0]           0x4B         00         RESERVED         ODD[7:0]         RESERVED           0x4D         00         RESERVED         RESERVED         ODD[7:0]         RESERVE											
DX3B   DX3C   DX3C   DX3C   DX3C   DX3C   DX3D   DX3C   DX3D   DX3E   DX3F					1400[4.0]	FBI	B[10:3]	1	EDDIO 01		
0x3C         00         NC[10:3]         NC[2:0]           0x3B         00         NSS[4:0]         NSS[12:5]           0x3F         40         Reserved         IPB[2:0]         RZB[1:0]           0x40         00         REFSELB         SSENB_B           0x41         00         REFC[7:0]         REFC[10:3]           0x43         00         Reserved         FBC[2:0]           0x44         00         FBC[2:0]         REFC[7:0]           0x44         00         IPC[2:0]         RZC[1:0]         Reserved           0x46         00         REFD[7:0]         REFD[7:0]           0x47         00         REFD[10:3]         FBD[10:3]           0x48         00         Reserved         FBD[10:3]           0x49         00         XDIVD         RZD[1:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]         REFSELD[1:0]           0x4B         00         Reserved         OD1[7:0]           0x4B         00         OD1[7:0]         REFSELD[1:0]           0x4B         00         RESERVED         RESERVED					MOD[4:0]	MO	D[10.E]		FBB[2:0]		_
0x3D         00         NSS[4:0]         NC[2:0]           0x3E         00         NSS[12:5]         RZB[1:0]           0x4F         40         Reserved         REFSELB         SSENB_B           0x40         00         REFC[7:0]         REFSELB         SSENB_B           0x41         00         REFC[7:0]         FBC[10:3]         FBC[2:0]         FBC[2:0]           0x43         00         RESERVED         FBC[2:0]         REFSELC         REFSELC           0x44         00         FBC[2:0]         RESERVED         REFSELC         REFSELC           0x45         00         IPC[2:0]         REFSELC         REFSELC <td></td> <td>_</td>											_
0x3E         00         NSS[12:5]           0x3F         40         Reserved         IPB[2:0]         RZB[1:0]           0x40         00         REFSELB         SSENB_B           0x41         00         REFC[7:0]         REFC[0:0]           0x42         00         FBC[10:3]         FBC[2:0]           0x43         00         Reserved         FBC[2:0]           0x44         00         FBC[2:0]         REFSELC           0x45         00         IPC[2:0]         REFC[7:0]           0x47         00         REFD[10:3]         FBD[2:0]           0x48         00         Reserved         FBD[2:0]           0x49         00         XDIVD         RZD[1:0]         IPD[2:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]         REFSELD[1:0]         OD0[7:0]           0x4D         00         OD1[7:0]         OD0[7:0]           0x4D         00         Reserved         REFSELD[1:0]					NSS[4:0]	140	7[10.5]		NC[5:0]		_
0x3F         40         Reserved         IPB[2:0]         RZB[1:0]           0x40         00         REFSELB         SSENB_B           0x41         00         REFC[7:0]         FBC[10:3]           0x42         00         FBC[10:3]         FBC[2:0]           0x43         00         Reserved         FBC2[7:0]           0x44         00         FBC2[7:0]         Reserved         XDIV         REFSELC           0x45         00         IPC[2:0]         REFD[7:0]         REFSELC         REFD[10:3]         FBD[10:3]         FBD[2:0]         REFSELD[1:0]					1400[4.0]	NS	S[12:5]		140[2.0]		_
0x40         00         Reserved         REFSELB         SSENB_B           0x41         00         REFC[7:0]				Reserved					RZ	B[1:0]	
0x42         00         FBC[10:3]           0x43         00         Reserved         FBC[2:0]           0x44         00         FBC2[7:0]         Reserved         XDIV         REFSELC           0x45         00         IPC[2:0]         RZC[1:0]         Reserved         XDIV         REFSELC           0x46         00         FBD[10:3]         FBD[2:0]         FBD[2:0]           0x47         00         FBD[2:0]         REFSELD[1:0]           0x48         00         RZD[1:0]         IPD[2:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]         REFSELD[1:0]         OD0[7:0]           0x4B         00         Reserved         OD1[7:0]         OD1[7:0]           0x4C         00         OD2[7:0]         Reserved           0x4B         00         REFSELD[1:0]         REFSELD[1:0]	0x40	00			Res	erved					
0x43         00         Reserved         FBC[2:0]           0x44         00         FBC2[7:0]         TBC2[7:0]           0x45         00         IPC[2:0]         RZC[1:0]         Reserved         XDIV         REFSELC           0x46         00         REFD[7:0]         TBD[10:3]         TBD[10:3]         TBD[2:0]         TBD[	0x41	00				REI	FC[7:0]				
0x44         00         FBC2[7:0]           0x45         00         IPC[2:0]         RZC[1:0]         Reserved         XDIV         REFSELC           0x46         00         REFD[7:0]	0x42	00				FBG	C[10:3]				
0x45         00         IPC[2:0]         RZC[1:0]         Reserved         XDIV         REFSELC           0x46         00         REFD[7:0]	0x43				Reserved				FBC[2:0]		
0x46         00         REFD[7:0]           0x47         00         FBD[10:3]           0x48         00         Reserved           0x49         00         XDIVD         RZD[1:0]           0x4A         00         ODD[7:0]           0x4B         00         Reserved           0x4C         00         OD1[7:0]           0x4D         00         OD2[7:0]           0x4E         00         Reserved											
0x47         00         FBD[10:3]           0x48         00         Reserved         FBD[2:0]           0x49         00         XDIVD         RZD[1:0]         IPD[2:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]				IPC[2:0]				Reserved	XDIV	REFSELC	
0x48         00         Reserved         FBD[2:0]           0x49         00         XDIVD         RZD[1:0]         IPD[2:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]         OD0[7:0]         OD0[7:0]         OD0[7:0]           0x4B         00         OD1[7:0]         OD0[7:0]         OD0[7:0]         OD0[7:0]           0x4D         00         OD2[7:0]         OD0[7:0]											
0x49         00         XDIVD         RZD[1:0]         IPD[2:0]         REFSELD[1:0]           0x4A         00         OD0[7:0]           0x4B         00         Reserved           0x4C         00         OD1[7:0]           0x4D         00         OD2[7:0]           0x4E         00         Reserved						FBI	D[10:3]				
0x4A         00         OD0[7:0]           0x4B         00         Reserved           0x4C         00         OD1[7:0]           0x4D         00         OD2[7:0]           0x4E         00         Reserved			VDIVD	D70			IDD(0:01			ELD[1:0]	_
0x4B         00         Reserved           0x4C         00         OD1[7:0]           0x4D         00         OD2[7:0]           0x4E         00         Reserved			עטועע	HZL	ر ۱.UJ	0			HEFS	בבט[ ו.ט]	<del> </del>
0x4C         00         OD1[7:0]           0x4D         00         OD2[7:0]           0x4E         00         Reserved											_
0x4D         00         OD2[7:0]           0x4E         00         Reserved											<del>- </del>
0x4E         00         Reserved								<del>- </del>			
											<del> </del>

	Default	Bit #								
Addr	Register Hex Value	7	6	5	4	3	2	1	0	Description
0x50	00	OD4[7:0]								
0x51	00				O	05[7:0]				
0x52	00	OD6[7:0]								
0x53	00	SCF	R6[1:0]	SCR	5[1:0]	SCR	4[1:0]	SCI	R3[1:0]	
0x54	00	Res	erved	SCR	2[1:0]	SCR	1[1:0]	Re	served	
0x55	00	SCF	RO[1:0]			Re	served			
0x56	00				Re	served				
0x57	00	PDB[6]	Reserved	OE[6B]	OE[6A]		Res	served		
0x58	00	OE[5]	OE[4]	OE[3]	Reserved	OE[2]	OE[1]	Reserved	OE[0]	
0x59	00	PDB[5]	PDB[4]	PDB[3]	Reserved	PDB[2]	PDB[1]	Reserved	PDB[0]	
0x5A	00			•	RE	FA[7:0]				Configuration2
0x5B	00				FB	A[10:3)				(See definitions from Configuration0 above)
0x5C	00			Reserved				FBA[2:0)		Cornigulationo above)
0x5D	00	Reserved	XDIVA	RZA	\[1:0]		IPA[2:0]		REFSELA	
0x5E	00		1		RE	FB[7:0]			I	
0x5F	00				FB	B[10:3]				
0x60	00			MOD[4:0]				FBB[2:0]		
0x61	00				МО	D[12:5]	l			
0x62	00				NC	C[10:3]				
0x63	00	NSS[4:0] NC[2:0]								
0x64	00	NSS[12:5]								
0x65	40	Reserved IPB[2:0] RZB[1:0]								
0x66	00	Reserved REFSELB SSENB_B								
0x67	00				RE	FC[7:0]		I	<u>I</u>	
0x68	00				FB	C[10:3]				
0x69	00	Reserved FBC[2:0]								
0x6A	00				FB	C2[7:0]	I .			
0x6B	00		IPC[2:0]		RZC	[1:0]	Reserved	XDIV	REFSELC	
0x6C	00	REFD[7:0]								
0x6D	00				FBI	D[10:3]				
0x6E	00	Reserved FBD[2:0]								
0x6F	00	XDIVD	RZD	0[1:0]		IPD[2:0]		REFS	ELD[1:0]	
0x70	00		1		OI	00[7:0]		I .		1
0x71	00				Re	served				1
0x72	00	OD1[7:0]								
0x73	00		OD2[7:0]						1	
0x74	00				Re	served				1
0x75	00	OD3[7:0]								
0x76	00	OD4[7:0]						†		
0x77	00	OD5[7:0]								
0x78	00	OD6[7:0]						1		
0x79	00	SCF	R6[1:0]	SCR	5[1:0]	SCR	4[1:0]	SCI	R3[1:0]	†
0x7A	00	Reserved SCR2[1:0] SCR1[1:0] Reserved						†		
0x7B	00	SCR0[1:0] Reserved						†		
0x7C	00				Re	served				1
0x7D	00	PDB[6] Reserved OE[6B] OE[6A] Reserved								
0x7E	00	OE[5]	OE[4]	OE[3]	Reserved	OE[2]	OE[1]	Reserved	OE[0]	_
0x7F	00	PDB[5]	PDB[4]	PDB[3]	Reserved	PDB[2]	PDB[1]	Reserved	PDB[0]	1

## **Marking Diagram (NL28)**

4802DI #YYWW\$

#### Notes:

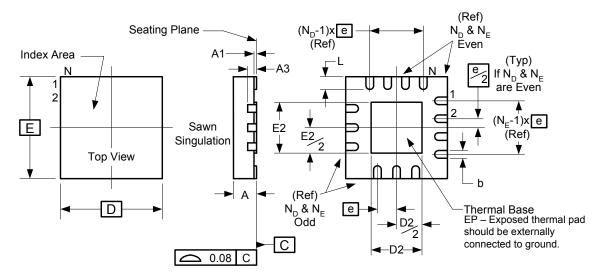
- 1. "Z" is the device step (1 to 2 characters).
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "\$" is the assembly mark code.
- 4. "G" after the two-letter package code designates RoHS compliant package.
- 5. "I" at the end of part number indicates industrial temperature range.
- 6. Bottom marking: country of origin if not USA.

## **Thermal Characteristics 28-pin QFN**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	$\theta_{\sf JA}$	Still air		47.0		°C/W
Ambient	$\theta_{\sf JA}$	1 m/s air flow		41.8		°C/W
	$\theta_{JA}$	2.5 m/s air flow		39.2		°C/W
Thermal Resistance Junction to Case	$\theta_{\sf JC}$			52.9		°C/W

### Package Outline and Package Dimensions (28-pin 4mm x 4mm QFN)

Package dimensions are kept current with JEDEC Publication No. 95



	Millimeters			
Symbol	Min	Max		
Α	0.80	1.00		
A1	0	0.05		
A3	0.20 Reference			
b	0.15	0.25		
е	0.40 BASIC			
N	28			
$N_D$	7			
N <sub>E</sub>	7			
D x E BASIC	4.00 x 4.00			
D2	2.50	2.70		
E2	2.50	2.70		
L	0.30	0.50		

## **Ordering Information**

Part / Order Number	Marking	<b>Shipping Packaging</b>	Package	Temperature
5P49EE802NDGI	See page 22	Tubes	28pin VFQFPN	-40 to +85° C
5P49EE802NDGI8	See page 22	Tape and Reel	28pin VFQFPN	-40 to +85° C

Parts that are ordered with a "G" after the two-letter pacakage code are the Pb-Free configuration and are RoHS compliant.

While the information presented herein has been checked for both accuracy and reliability, Integrated Device Technology (IDT) assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

## **Revision History**

Rev.	Originator	Date	Description of Change
	R.Willner 10/14/09 Initial Preliminary Datasheet		Initial Preliminary Datasheet
Α	A R.Willner 11/20/09		No_PD bit inclusion - 32kHz clock on/off in Config 00.
В	R.Willner	3/25/10	Typographical changes. Correct spread spectrum calculations.
С	R.Willner	6/18/10	Typographical changes. Default configuration.

## Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775 For Tech Support

408-284-4522 clockhelp@idt.com

#### **Corporate Headquarters**

Integrated Device Technology, Inc. www.idt.com

